



40V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D T _C = +25°C	
40V	$10m\Omega @ V_{GS} = 10V$	100A	

Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

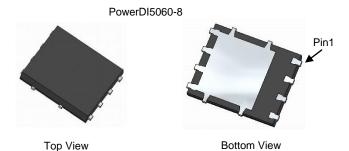
- Engine Management Systems
- DC-DC Converters
- Body Control Electronics

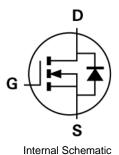
Features and Benefits

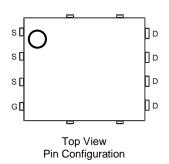
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low Q_g Minimizes Switching Loss
- Low R_{DS(ON)} Minimizes On State Loss
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: PowerDI5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)







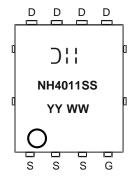
Ordering Information (Note 5)

Part Number	Case	Packaging	
DMNH4011SPSQ-13	PowerDI5060-8	2,500 / Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



);; = Manufacturer's Marking
NH4011SS = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 16 = 2016)
WW = Week (01 to 53)



Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	40	V
Gate-Source Voltage		V _{GSS}	±20	V
	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	12.9 10.8	А
Continuous Drain Current (Note 7) V _{GS} = 10V	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$ (Note 8)	I _D	100 65	А
Maximum Continuous Body Diode Forward Current (Note 6)		I _S	2.7	Α
Pulsed Drain Current (10μs pulse, duty cycle = 1%)		I _{DM}	90	Α
Avalanche Current, L = 1mH		I _{AS}	18.7	Α
Avalanche Energy, L = 1mH		E _{AS}	176	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	P_{D}	2.5	W
Thermal Resistance, Junction to Ambient (Note 6)		$R_{\theta JA}$	60	°C/W
Total Power Dissipation (Note 7)	T _C = +25°C	P _D	150	W
Thermal Resistance, Junction to Case (Note 7)		R _{0JC}	1	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 40V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	8.5	10	mΩ	$V_{GS} = 10V, I_D = 50A$	
Diode Forward Voltage	V_{SD}	_	0.9	1.2	V	$V_{GS} = 0V, I_S = 50A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	_	1405	_			
Output Capacitance	Coss	_	247	_	pF	$V_{DS} = 20V, V_{GS} = 0V, f = 1MHz$	
Reverse Transfer Capacitance	C _{rss}	_	108	_			
Gate Resistance	Rg	_	2.2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	25.5	_			
Gate-Source Charge	Q _{gs}	_	4.6	_	nC	$V_{DS} = 20V, V_{GS} = 10V, I_{D} = 50A$	
Gate-Drain Charge	Q_{gd}	_	6.9	_			
Turn-On Delay Time	t _{D(ON)}	_	4.6	_		$V_{DD} = 20V, V_{GS} = 10V,$ $I_{D} = 50A, R_{G} = 3.5\Omega$	
Turn-On Rise Time	t _R	_	3.7	_	ns		
Turn-Off Delay Time	t _{D(OFF)}	_	16	_	115		
Turn-Off Fall Time	t _F	_	5.1	_			
Body Diode Reverse Recovery Time	t _{RR}	_	22.1	_	ns	I FOA di/dt 100A/us	
Body Diode Reverse Recovery Charge	Q _{RR}	_	13.4	_	nC	$I_F = 50A$, di/dt = 100A/ μ s	

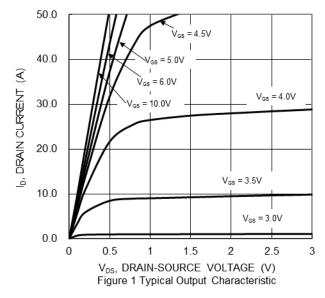
Notes:

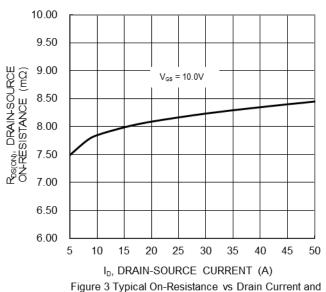
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.7. Thermal resistance from junction to soldering point (on the exposed drain pad).8. Short duration pulse test used to minimize self-heating effect.

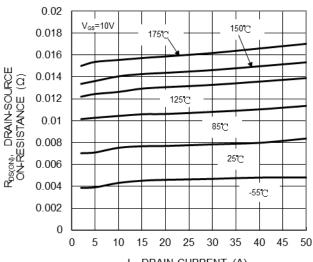
- 9. Guaranteed by design. Not subject to production testing.





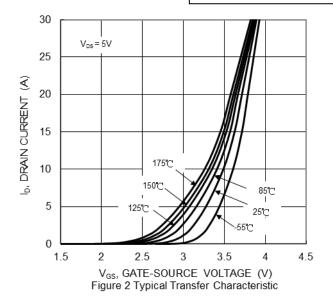


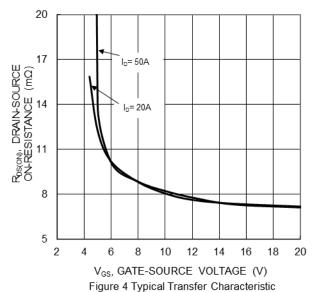


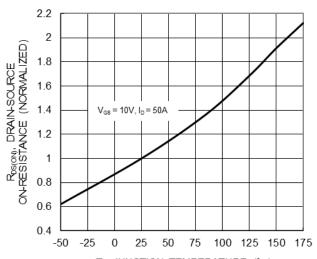


I_D, DRAIN CURRENT (A) Figure 5 Typical On-Resistance vs Drain Current and Temperature

Gate Voltage







 $T_{J},\; JUNCTION\;\; TEMPERATURE\;\;(^{\circlearrowright}_{L})$ Figure 6 On-Resistance Variation with Temperature





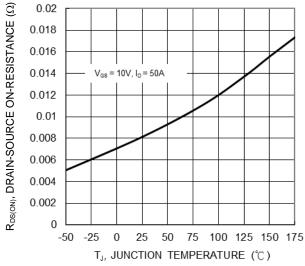


Figure 7 On-Resistance Variation with Temperature

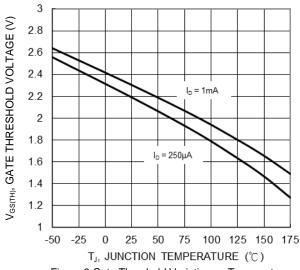


Figure 8 Gate Threshold Variation vs Temperature

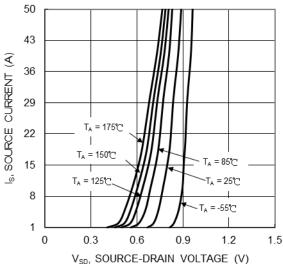
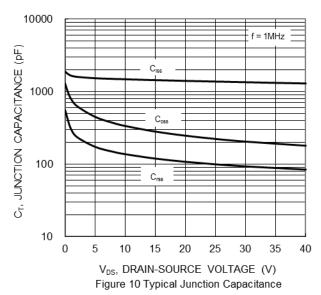


Figure 9 Diode Forward Voltage vs Current



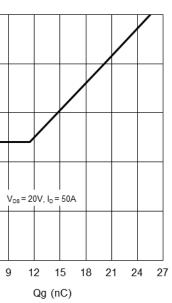


Figure 11 Gate Charge

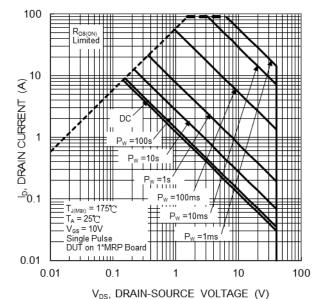


Figure 12 SOA, Safe Operation Area

10

8

6

4

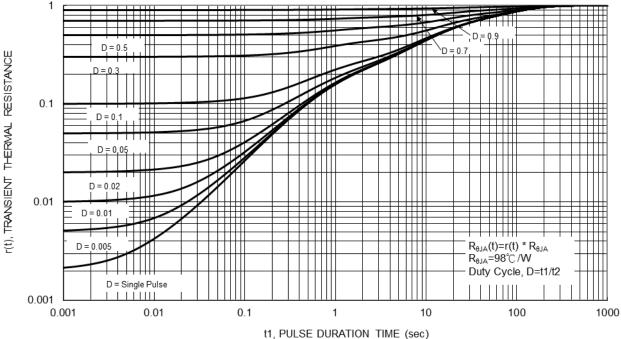
2

0

0 3 6

V_{GS} (V)



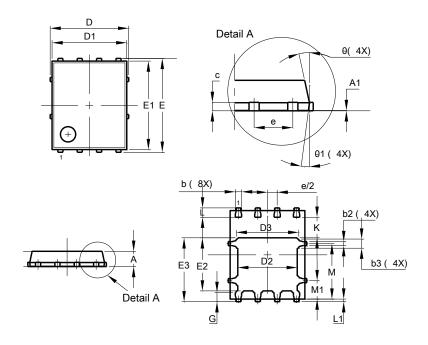




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8

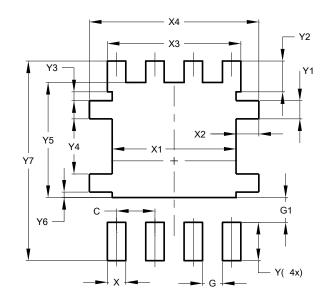


PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC			
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	(6.15 BSC			
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12º	11º		
Θ1	6º	8°	7º		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610



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